1-7. (Cancelled)

application:

- 8. (Original) A transistor comprising:
  - a remaining portion of an emitter landing pad that is distanced from an intrinsic base.
- 9. (Origina) The transistor of claim 8, wherein the remaining portion is distanced from the intrinsic base by an extrinsic base layer, and the extrinsic base layer includes an oxide section that determines a distance between an emitter and an extrinsic base.
- 10. (Origina) The transistor of claim 9, wherein a width of the oxide section determines a base resistance.
- 11. (Original) The transistor of claim 10, wherein the width of the oxide section determines a length of the remaining portion that current must traverse as current passes through the extrinsic base.
- 12. (Original) The transistor of claim 11, wherein the thickness of the oxide section is sufficient to prevent current from having to traverse the remaining portion.

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26. (Origina) The transistor of claim 25, wherein the extrinsic base includes a first layer and a second layer, and the oxide section is positioned within the first layer, and the first layer includes a first region including a doped silicon and a second region including a doped polysilicon.

27-30. (Cancelled)

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